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U.S. PTO  
09/619359

To the Honorable Commissioner of Patents and Trademarks: Please

1. Name of conveying party(ies):

**JUAN BOON TAN, TAK YAN TSE, SAJAN  
MAROKKEY RAPHAEL AND FANG HONG GN**

Name: **Chartered Semiconductor Manufacturing Ltd.**

Additional name(s) or conveying party(ies) attached?  Yes  No

Internal Address:

Street Address:

**60 Woodlands Industrial Park D  
Street 2  
City: Singapore Zip: 738406  
Country: Singapore**

3. Nature of conveyance

- Assignment  Merger
- Security Agreement  Change of Name
- other \_\_\_\_\_

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Execution Date: **6/16/00**

4. Application number(s) or patent number(s):

*09/619359*

If this document is being filed together with a new application, the execution date of the application is: **6/16, 6/19 &**

**A. Patent Application No(s)**

**B. Patent No.(s) 6/27/00**

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **GEORGE O. SAILE**

Internal Address: \_\_\_\_\_

Street Address: **20 MCINTOSH DRIVE**

City: **POUGHKEEPSIE** State: **NY** ZIP: **12603**

6. Total no. of applications and patents involved: **1**

7. Total fee (37 CFR 3.41): **\$ 40.00**

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Signature

**July 17, 2000**

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Total number of pages comprising cover sheet: **3**

For  U.S. and/or  Foreign Rights

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### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR:

JUAN BOON TAN  
Type or print name of ASSIGNOR

136A HILLVIEW AVENUE,  
Address

\*07-04 MERAWOODS, S'PORE 609606

MALAYSIAN  
Nationality

TAK YAN TSE  
Type or print name of ASSIGNOR

BLOCK 259 BUKIT PANJANG RING RD  
Address

#08-16 SINGAPORE 671259

BRITISH NATIONAL OVERSEAS  
Nationality

SAJAN MARICKKY RAPHAEL  
Type or print name of ASSIGNOR

BLK-308, #07-244, Jurong R. S732  
Address

SINGAPORE - 600 308

INDIAN  
Nationality

FANG HONG GN  
Type or print name of ASSIGNOR

BLK 209, Clementi Ave 6  
Address

#13-05

Singaporean  
Nationality

#### ASSIGNEE:

**Chartered Semiconductor Manufacturing Ltd.**  
**60 Woodlands Industrial Park D**  
**Street 2**  
**Singapore 738406**  
**Singapore**  
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- the entire right, title and interest
- an undivided \_\_\_\_\_ percent (\_\_\_\_%) interest for the United States and its territorial possessions  
(check the following box if foreign rights are also to be assigned)
- and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

**Accurate Wafer Patterning Method For Mass Production**

and which is found in

- (a)  U.S. patent application executed on even date herewith
- (b)  U.S. patent application executed on 6/11/00, 6/19/00 & 6/27/00
- (c)  U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_
- (d)  U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
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ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

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IN WITNESS WHEREOF, I / We have signed this  
16 JUNE 2000 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Tok Yuen Tse  
Signature of ASSIGNOR(S)  
Tok Yuen Tse, 2/8/99

[Signature]  
\_\_\_\_\_  
[Signature]  
\_\_\_\_\_

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

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Notarization or Legalization Page Added.